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Vishay Siliconix

# Automotive P-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-30			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0085			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0200			
I <sub>D</sub> (A)	-22			
Configuration	Single			
Package	SO-8			

#### **FEATURES**

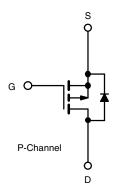
- TrenchFET® power MOSFET
- AEC-Q101 qualified c
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE





<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> (T <sub>C</sub> = 25 °C, unless	s otherwise noted	1)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	-30	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	V
Continuous Drain Current	T <sub>C</sub> = 25 °C	I <sub>D</sub>	-30	
	T <sub>C</sub> = 125 °C		-30	
Continuous Source Current (Diode Conduction)		I <sub>S</sub>	-30	Α
Pulsed Drain Current a		I <sub>DM</sub>	-84	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-32	
Single Pulse Avalanche Energy	L = 0.1 IIIIA	E <sub>AS</sub>	51	mJ
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	D	7	W
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	2	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount b	$R_{thJA}$	85	°C/W	
Junction-to-Foot (Drain)		$R_{thJF}$	21	- C/VV	

### Notes

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. Parametric verification ongoing.



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT	
Static		-						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-30	-	-	.,	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-2.0	-2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA	
		V <sub>GS</sub> = 0 V	$V_{DS} = -30 \text{ V}$	-	-	-1	†	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -30 V, T <sub>J</sub> = 125 °C	-	-	-50	μΑ	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -30 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = -10 \text{ V}$	$V_{DS} \le -5 \text{ V}$	-30	-	=	Α	
Drain-Source On-State Resistance a		$V_{GS} = -10 \text{ V}$	I <sub>D</sub> = -10 A	-	0.0070	0.0085	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C	-	-	0.0130		
	20(011)	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C	-	-	0.0150		
			$V_{GS} = -4.5 \text{ V}$ $I_D = -7 \text{ A}$		0.0160	0.0200		
Forward Transconductance b	9fs	V <sub>DS</sub> =	= -10 V, I <sub>D</sub> = -10 A	-	32	-	S	
Dynamic <sup>b</sup>	T	1				T	1	
Input Capacitance	C <sub>iss</sub>		/ V <sub>DS</sub> = -15 V, f = 1 MHz	-	3400	4500	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	712	890		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	580	770		
Total Gate Charge c	$Q_g$			-	75	113		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = -10 \text{ V}$	$V_{DS} = -15 \text{ V}, I_{D} = -10 \text{ A}$	-	9.5	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>				19	-		
Gate Resistance	$R_g$		f = 1 MHz		2	3	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	20	25		
Rise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD}$ = -15 V, $R_L$ = 1.5 $\Omega$		146	189	ns	
Turn-Off Delay Time c	t <sub>d(off)</sub>	$I_D \cong$ -10 A, $V_{GEN} =$ -10 V, $R_g =$ 1 $\Omega$		-	57	75		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	20	25		
Source-Drain Diode Ratings and Chara	acteristics b							
Pulsed Current a	I <sub>SM</sub>			-	-	-84	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = -3 A, V <sub>GS</sub> = 0 V		_	-0.75	-1.2	V	
	. 30		, do		l	1		

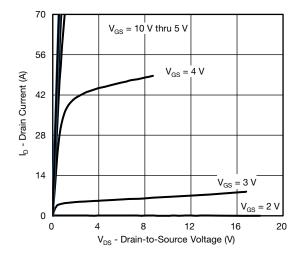
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

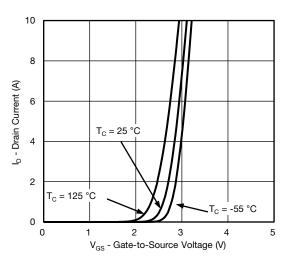
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



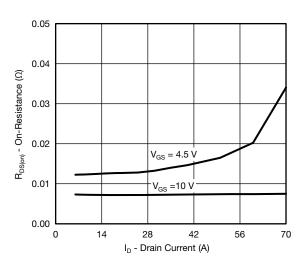
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



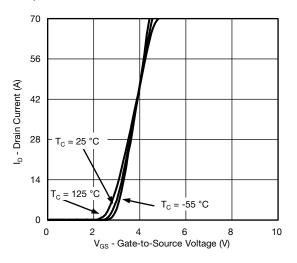
### **Output Characteristics**



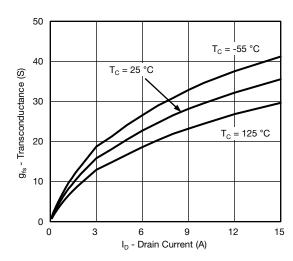
## Transfer Characteristics



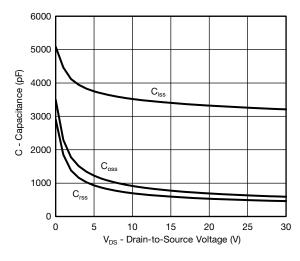
On-Resistance vs. Drain Current



### **Transfer Characteristics**

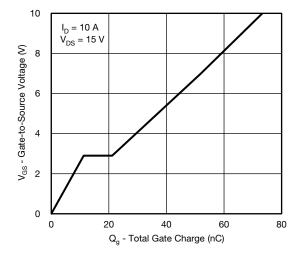


## Transconductance

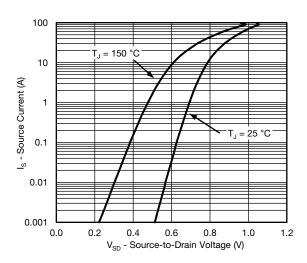




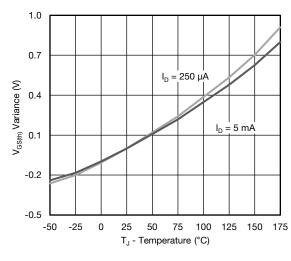
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



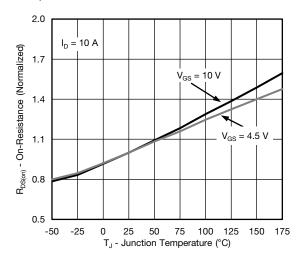
### **Gate Charge**



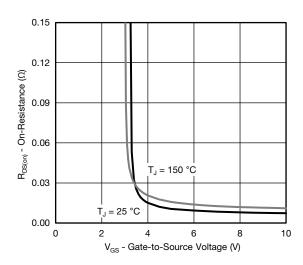
### **Source Drain Diode Forward Voltage**



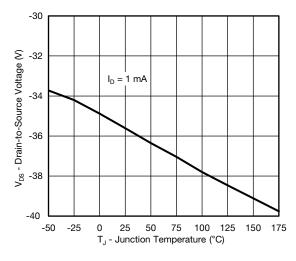
**Threshold Voltage** 



On-Resistance vs. Junction Temperature



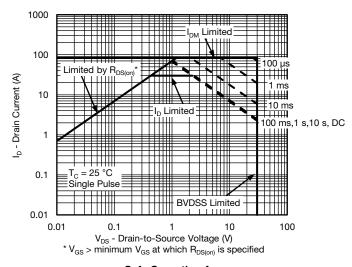
On-Resistance vs. Gate-to-Source Voltage



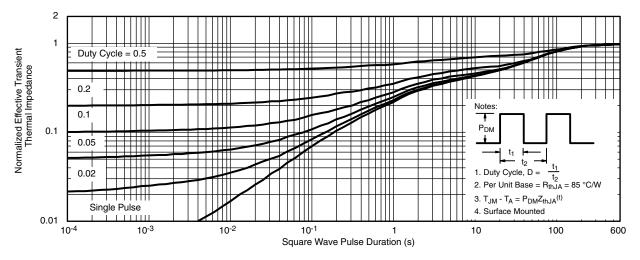
Drain Source Breakdown vs. Junction Temperature



# **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



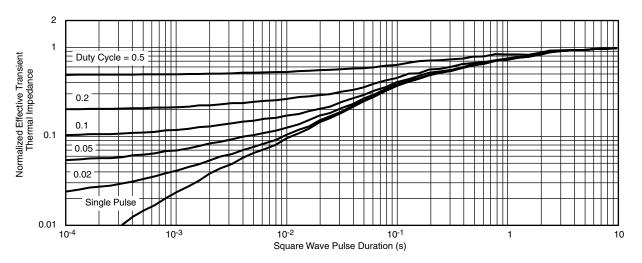
### Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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## **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Foot

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg274794">www.vishay.com/ppg274794</a>.



# **SO-8**

Ordering codes for the SQ rugged series power MOSFETs in the SO-8 package:

DATASHEET PART NUMBER	OLD ORDERING CODE a	NEW ORDERING CODE	
SQ4005EY	-	SQ4005EY-T1_GE3	
SQ4050EY	SQ4050EY-T1-GE3	SQ4050EY-T1_GE3	
SQ4182EY	SQ4182EY-T1-GE3	SQ4182EY-T1_GE3	
SQ4184EY	SQ4184EY-T1-GE3	SQ4184EY-T1_GE3	
SQ4282EY	SQ4282EY-T1-GE3	SQ4282EY-T1_GE3	
SQ4284EY	SQ4284EY-T1-GE3	SQ4284EY-T1_GE3	
SQ4401EY	SQ4401EY-T1-GE3	SQ4401EY-T1_GE3	
SQ4410EY	SQ4410EY-T1-GE3	SQ4410EY-T1_GE3	
SQ4425EY	SQ4425EY-T1-GE3	SQ4425EY-T1_GE3	
SQ4431EY	SQ4431EY-T1-GE3	SQ4431EY-T1_GE3	
SQ4435EY	SQ4435EY-T1-GE3	SQ4435EY-T1_GE3	
SQ4470EY	SQ4470EY-T1-GE3	SQ4470EY-T1_GE3	
SQ4483BEEY	SQ4483BEEY-T1-GE3	SQ4483BEEY-T1_GE3	
SQ4483EY	-	SQ4483EY-T1_GE3	
SQ4532AEY	-	SQ4532AEY-T1_GE3	
SQ4840EY	SQ4840EY-T1-GE3	SQ4840EY-T1_GE3	
SQ4850EY	SQ4850EY-T1-GE3	SQ4850EY-T1_GE3	
SQ4917EY	SQ4917EY-T1-GE3	SQ4917EY-T1_GE3	
SQ4920EY	SQ4920EY-T1-GE3	SQ4920EY-T1_GE3	
SQ4937EY	SQ4937EY-T1-GE3	SQ4937EY-T1_GE3	
SQ4940AEY	SQ4940AEY-T1-GE3	SQ4940AEY-T1_GE3	
SQ4946AEY	SQ4946AEY-T1-GE3	SQ4946AEY-T1_GE3	
SQ4949EY	SQ4949EY-T1-GE3	SQ4949EY-T1_GE3	
SQ4961EY	SQ4961EY-T1-GE3	SQ4961EY-T1_GE3	
SQ9407EY	SQ9407EY-T1-GE3	SQ9407EY-T1_GE3	
SQ9945BEY	SQ9945BEY-T1-GE3	SQ9945BEY-T1_GE3	

### Note

a. Old ordering code is obsolete and no longer valid for new orders



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000

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IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI

DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384

NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956

NTE2911 US6M2GTR TK10A80W,S4X(S SSM6P69NU,LF